

O-leading

O-Leading PCB PCB PCB PCB EMS HDI PCB PCB PCB PCB

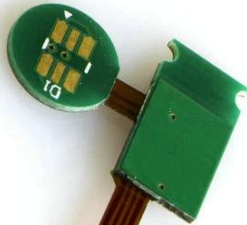
O

O-leading PCB&PCBA

[PCB](#)

Fast delivery and low cost

Rigid Flexible PCB



O-LEADING
To Be Reliable, To Be Valuable





Production Process

18 years experience in one-stop PCB and PCBA, we can make your idea come true,



 CONSUMER ELECTRONICS

 AUTOMOTIVE ELECTRONICS

 INDUSTRIAL CONTROL

 INTELLECTUALIZED HOUSEHOLD CONTROL

 OTHER



30%
CONSUMER ELECTRONICS



12%
OTHER



20%
INDUSTRIAL CONTROL

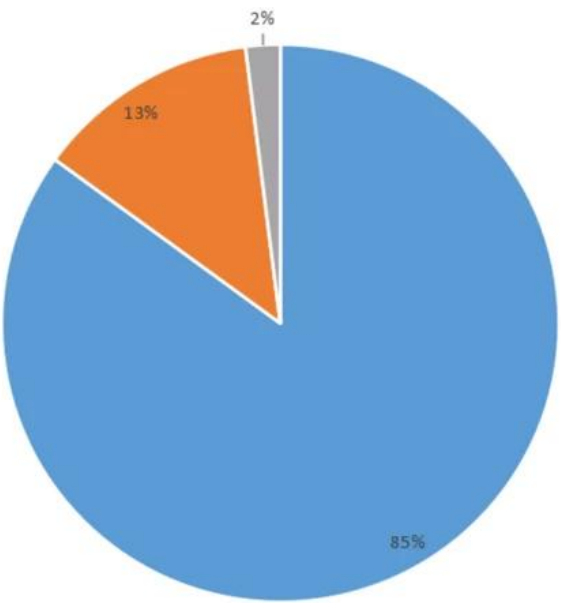


18%
INTELLECTUALIZED HOUSEHOLD CONTROL

20%
AUTOMOTIVE ELECTRONICS

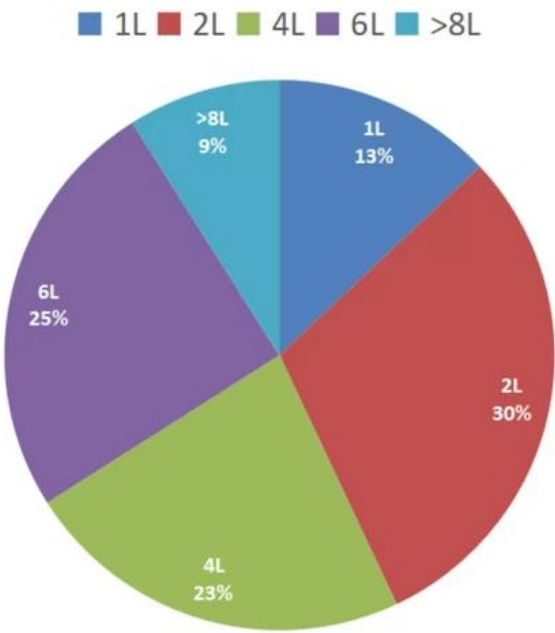


Product types



■ FR-4 PCB ■ MC PCB ■ rigid-flexible PCB

Product layers



■ 1L ■ 2L ■ 4L ■ 6L ■ >8L

□□□□□□



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Skyworth 创维

HET 和而泰
HET INTELLIGENT CONTROL

dongweikeji
东威科技

美的 Midea

STAR-NET
星网锐捷

FORYOU
ADAYO 华阳集团

EDIFIER®

Cultraview 金锐显

3nod 三诺

T&W

TCL

AcBel 康舒科技
ACBEL POLYTECH INC.

Honeywell

Schneider
Electric

ZTE 中兴

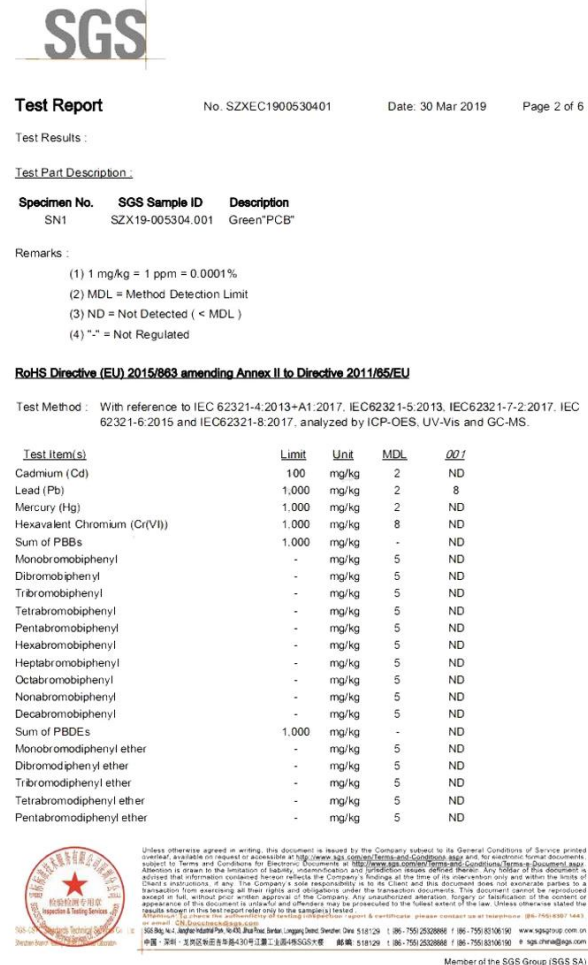
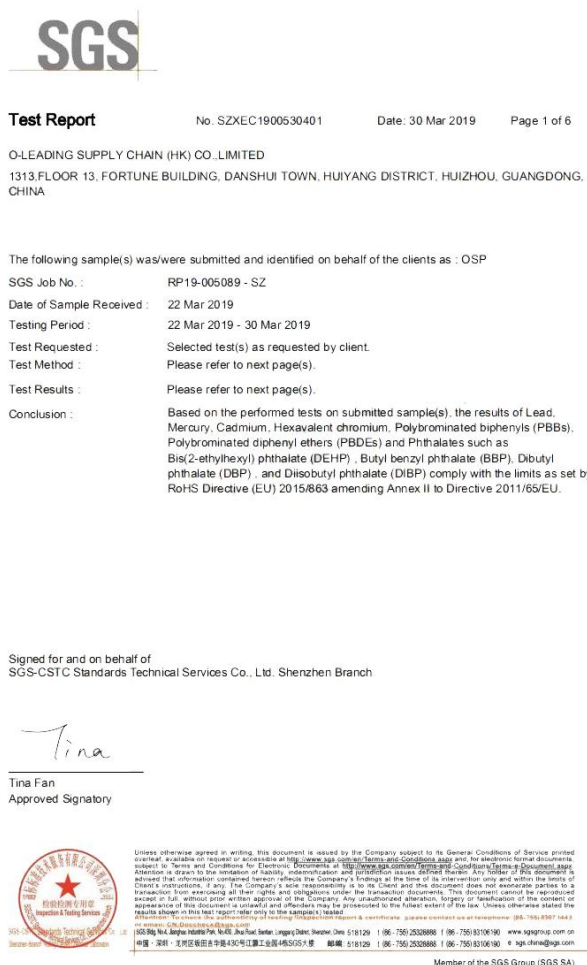
EMERSON

BYD

PHILIPS

TE
connectivity

VIDEOTON





ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Max		Max		Meets		C
	Min	Edge			Area	Solder	Oper	Flame	UL796	T	
	mm(in)	mm(in)			Diam	Limits	Temp	Class	DSR	I	
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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PCB

PCB	
Layer	1Layer-32Layer
Weight	1 / 3oz-12oz
Thickness	3.0mil / 3.0mil
Thickness	4.0mil / 4.0mil
Thickness	10
Thickness	0.2mm-5.0mm
Thickness	635 * 1500mm
Thickness	4mil
Plated	+/- 3mil
Blind / Buried Vias	All
Via Fill	
Material	FR-4FR-4high Tg
Material	HASLOSPENIGHAL-LF

SMT	
PCB	FR-4CEM-1CEM-3
PCB	510x460mm
PCB	50x50mm
PCB	0.5mm-4.5mm
Thickness	0.5-4mm
Thickness	0201
Thickness	0603
Thickness	15mm
Thickness	0.3mm
Thickness	0.4mm
Thickness	+/- 0.03mm

PCB

Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days



1. O

1.1

1.2

1.3

1.4

1.5

2. O-Leading

3. O-Leading

4. PCB與PCBA的區別

- 4.1 BOM
- 4.2 PCB
- 4.3 PCB與PCBA
- 4.4
- 4.5

5. PCB的生產流程

→AOI→PTH→→→→→E / T→

6. HDI

VCPLDI
LDI

7. O-

O-ENIGOSP+ENIGHDI0.3 mmOSP OSP + ENIG

8. FPC與O-LeadingSMT

O-LeadingFPC182000mm * 240mmSMT

9. PCB

;
;
;
;
PCB;
;
;

10. PCB、PWB、FPC

PCB
PWBPrinted Wire Board
FPC

11. PCB

PCBTgCTEPCB250°C50PCB

12. O-leadingPCB

O-leadingPCBFPCPCB

13.

POLAR INSTRUMENTSSI6000 softCITS 500s

